## **Amendments to the Drawings:**

The attached sheet of drawings includes changes to FIG. 1. This sheet, which includes FIGS. 1 and 2, replaces the original sheet including FIGS. 1 and 2.

## **REMARKS**

No new matter has been added. The amendments to the claims address typographical and spelling errors, and improve antecedent basis. The amendments do not surrender any scope of any claim as originally filed.

The Applicant again requests entry of the amendments as set forth herein prior to examination of the application on the merits.

Respectfully submitted,

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Date: January 19, 2007

ERC/sfc:tlp

Attachment: Replacement Sheet

**Annotated Sheet Showing Changes** 

Document in ProLaw

TITLE: SEMICONDUCTOR DEVICE WITH IMPROVED BOND PADS

Inventor: Rodney C. Langley
Serial No.: 09/438,692
Docket No.: 2269-3656US
ANNOTATED SHEET SHOWING CHANGES

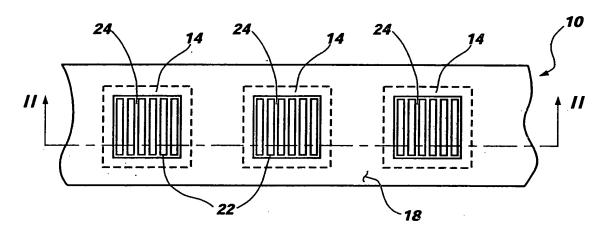


FIG. 1 (AMENDED)

